| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|----------|------|--|---|---------------------|---------|------------------|
| 12 | 6 | 277/919 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:38 |
| L3 | 13 | 277/920 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:40 |
| L4 | 370 | 361/799 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:31 |
| L5 | 43 | 361/799 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:41 |
| L6 | 66 | 361/752 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:35 |
| L7 | 18 | 361/728 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:32 |
| L8 | . 16 | 361/730 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:32 |
| L9 | 4 | 361/692 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:32 |
| L10 | 88 | 361/800 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:45 |

| L11 | 118 | 361/816 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:32 |
|-----|-----|---|---|----|-----|------------------|
| L12 | 140 | 361/818 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25:09:33 |
| L14 | 121 | 174/35R and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:34 |
| L15 | 99 | 174/35GC and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:49 |
| L16 | 52 | 174/35MS and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:33 |
| L17 | 8 | 174/32 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:33 |
| L18 | 3 | 174/50 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:34 |
| L19 | 13 | 174/52.1 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:34 |
| L20 | 44 | 361/796 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:35 |
| L21 | 14 | 361/797 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:35 |

| L22 | 3 | 361/798 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:35 |
|-----|----|--|---|----|-----|------------------|
| L23 | 57 | 361/753 and (housing or chassis or enclosure) and (circuit adj1(board or card or module)) and (EMI or EMC) and gasket | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:35 |
| S14 | 42 | (barringer adj1 dennis).in. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/25 09:29 |
| S15 | 3 | "6608759" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/03/24 14:04 |